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August 2015

### FCPF1300N80Z N-Channel SuperFET<sup>®</sup> II MOSFET

#### **800 V, 6 A, 1.3** Ω

#### Features

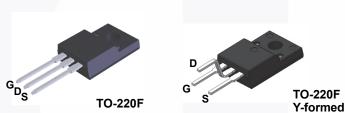
- R<sub>DS(on)</sub> = 1.05 Ω (Typ.)
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 16.2 nC)
- Low E<sub>oss</sub> (Typ. 1.57 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C<sub>oss(eff.)</sub> = 48.7 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

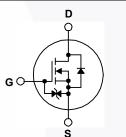
#### Applications

- AC DC Power Supply
- LED Lighting

#### Description

SuperFET<sup>®</sup> II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress. Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.





#### Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FCPF1300N80Z FCPF1300N80ZYD	Unit V			
V <sub>DSS</sub>	Drain to Source Voltage	800				
N/	Cata ta Cauraa Valtaga	- DC	- DC			
V <sub>GSS</sub>	Gate to Source Voltage	- AC	±30	V		
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	6.0*	А		
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C)		3.8*	A	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	12*	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)			48	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)			0.8	Α	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)			0.26	mJ	
dv/dt	MOSFET dv/dt			100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)			20		
D	Devues Dissingtion	(T <sub>C</sub> = 25°C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		W	
P <sub>D</sub>	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C		W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
T	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

#### Thermal Characteristics

Symbol	Parameter	FCPF1300N80Z FCPF1300N80ZYD	Unit			
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.2	00004			
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W			

FCPF1300N80Z
I
N-Channel SuperFET®

Part Nu	mber	Top Mark Pa		kage	Packing Method	Reel S	ize	Tape Wid	lth C	uantity	
FCPF1300N80Z FCPF1300N80Z TC   FCPF1300N80ZVD FCPF1300N80Z TC		FCPF1300N80Z	TO-220F		Tube	-		N/A	Ę	50 units	
			0-220F Tube N/A		N/A		50 units				
	l Chara	cteristics T <sub>C</sub> = 25	5°C unle	ess othe	erwise noted.				I		
Symbol		Parameter			Test Conditions		Min.	Тур.	Max.	Unit	
Off Charac	teristics										
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		ade	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C			800	-	-	V	
∆BV <sub>DSS</sub>							000				
$\Delta T_{J}$	Breakdown Voltage Temperature Coefficient			$I_D = 1 \text{ mA}$ , Referenced to $25^{\circ}$ C			-	0.85	-	V/ºC	
	Zana Cata	ate Voltage Drain Current		V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	25			
DSS	Zero Gate				640 V, V <sub>GS</sub> = 0 V,T <sub>C</sub>	= 125 <sup>o</sup> C	-	-	250	μA	
I <sub>GSS</sub>	Gate to B	Gate to Body Leakage Current			±20 V, V <sub>DS</sub> = 0 V	1	-	-	±10	μA	
On Charac	teristics										
V <sub>GS(th)</sub>	Gate Thre	shold Voltage		V <sub>GS</sub> =	V <sub>DS</sub> , I <sub>D</sub> = 0.4 mA		2.5	-	4.5	V	
R <sub>DS(on)</sub>	Static Dra	in to Source On Resista	ance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2 \text{ A}$			-	1.05	1.3	Ω	
9 <sub>FS</sub>	Forward Transconductance			V <sub>DS</sub> = 20 V, I <sub>D</sub> = 2 A			-	4.5	-	S	
Dynamic C	haracter	istics									
C <sub>iss</sub>	Input Cap	acitance					-	661	880	pF	
C <sub>oss</sub>	Output Capacitance			$V_{\rm DS} = 100 \text{ V}, V_{\rm GS} = 0 \text{ V},$		-	22.3	30	pF		
C <sub>rss</sub>		Fransfer Capacitance		f = 1 MHz		-	0.74	-	pF		
C <sub>oss</sub>	Output Capacitance			V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz			-	11.4	-	pF	
C <sub>oss(eff.)</sub>	Effective Output Capacitance			$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$			-	48.7	-	pF	
Q <sub>g(tot)</sub>	Total Gate	e Charge at 10V		-	640 V, I <sub>D</sub> = 4 A,		-	16.2	21	nC	
Q <sub>gs</sub>	Gate to S	ource Gate Charge		$V_{GS} =$		-	-	3.5	-	nC	
Q <sub>gd</sub>	Gate to D	rain "Miller" Charge				(Note 4)	-	6.8	-	nC	
ESR	Equivalen	t Series Resistance		f = 1 N	lHz		-	4	-	Ω	
Switching	Characte	eristics									
t <sub>d(on)</sub>	Turn-On [	Delay Time					-	14	38	ns	
t <sub>r</sub>	Turn-On F			$V_{DD}$ = 400 V, I <sub>D</sub> = 4 A, $V_{GS}$ = 10 V, R <sub>g</sub> = 4.7 Ω (Note 4)		-		8.3	27	ns	
t <sub>d(off)</sub>	Turn-Off	Delay Time				-	33	76	ns		
t <sub>f</sub>	Turn-Off F					-	6	22	ns		
	rce Diode	e Characteristics	I								
I <sub>s</sub>	Maximum Continuous Drain to Source			Diode Forward Current		-	-	6	A		
ISM	Maximum Pulsed Drain to Source Diod						_	-	12	A	
V <sub>SD</sub>		ource Diode Forward V			0 V, I <sub>SD</sub> = 4 A		_	-	1.2	V	
t <sub>rr</sub>		Recovery Time	5				-	275	-	ns	
Q <sub>rr</sub>		Recovery Charge		V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 4 A, dI <sub>F</sub> /dt = 100 A/μs		-	2.9	-	μC		

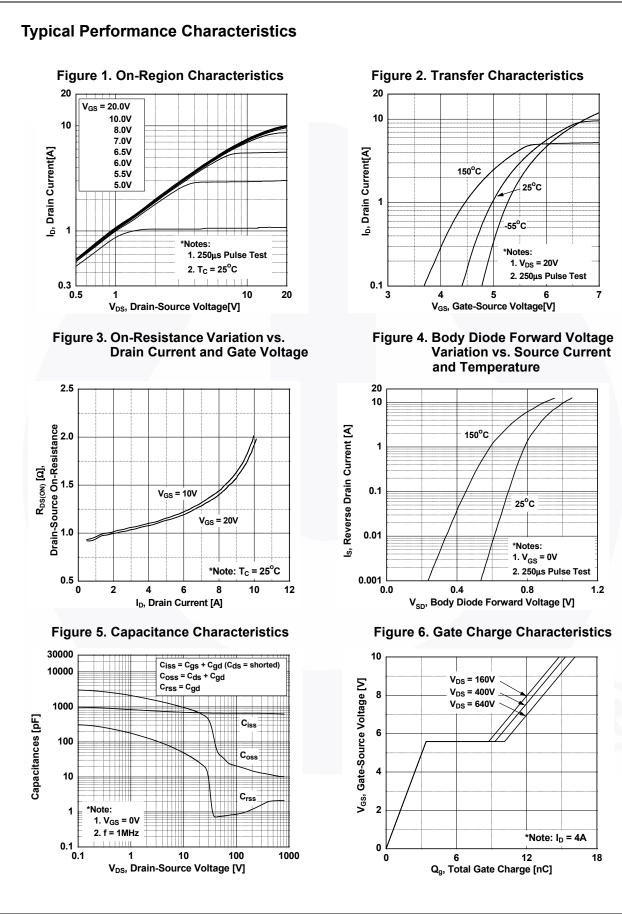
Notes:

1. Repetitive rating: pulse width limited by maximum junction temperature.

2.  $I_{AS}$  = 0.8 A,  $R_G$  = 25  $\Omega_{\!\!,}$  starting  $T_J$  = 25°C

3. I\_{SD} \leq 6 A, di/dt  $\leq$  200 A/µs, V\_{DD}  $\leq$  BV\_{DSS}, starting T\_J = 25°C

4. Essentially independent of operating temperature typical characteristic.



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\*Notes:

1. V<sub>GS</sub> = 10V

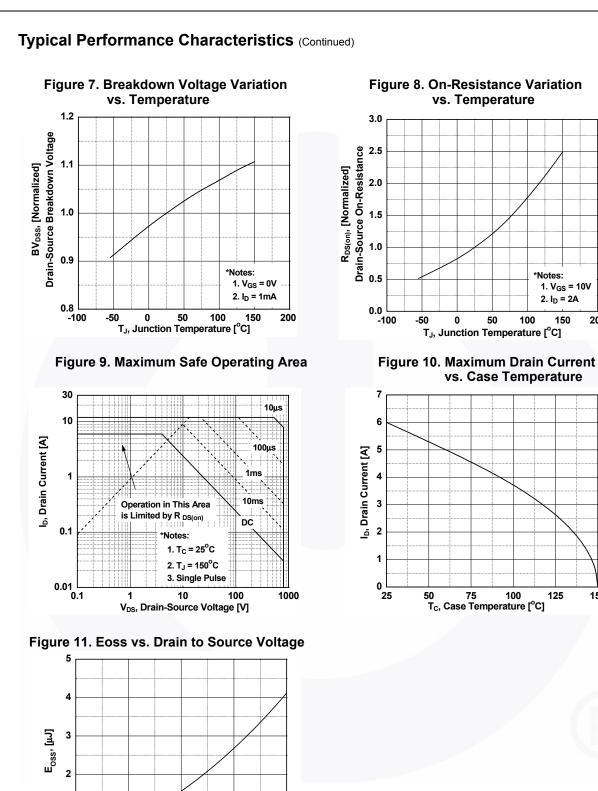
2. I<sub>D</sub> = 2A

150

200

150

125



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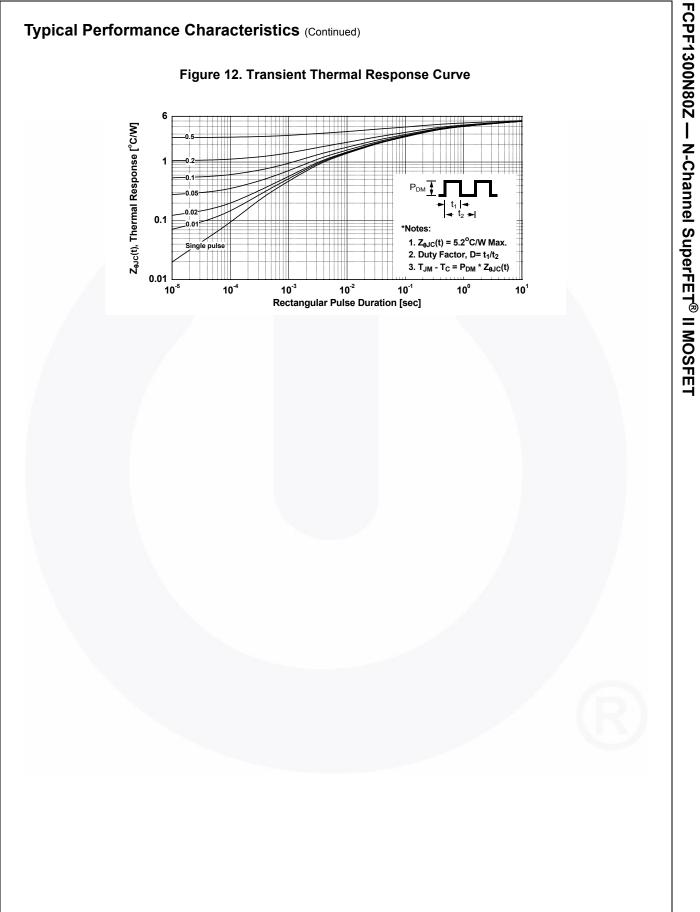
200 400 600 V<sub>DS</sub>, Drain to Source Voltage [V]

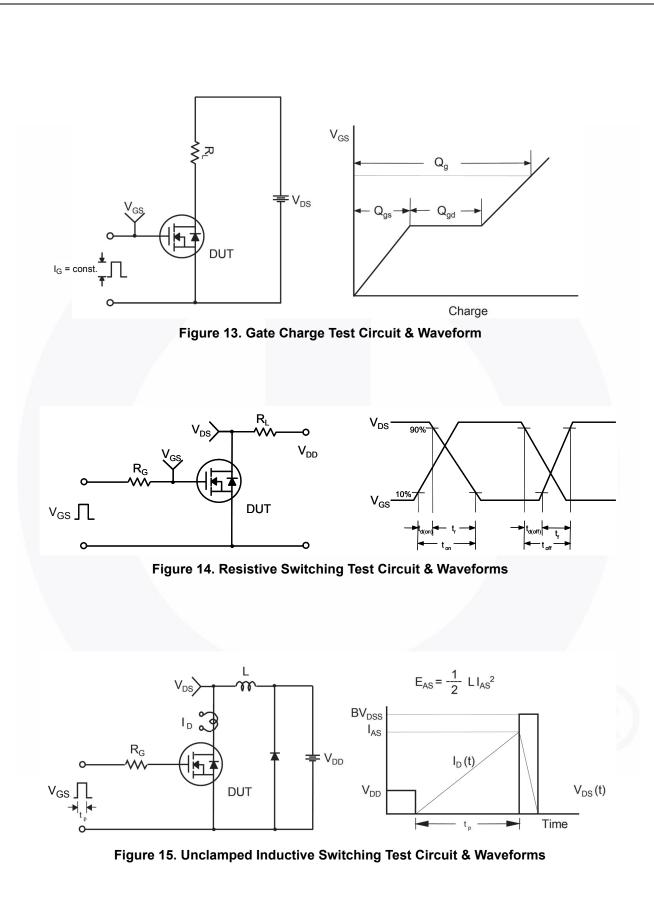
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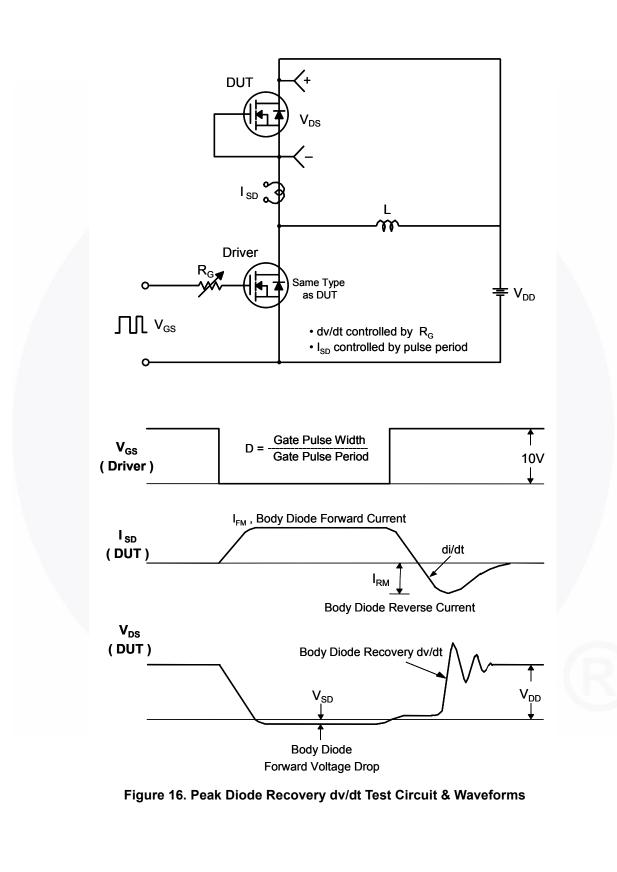
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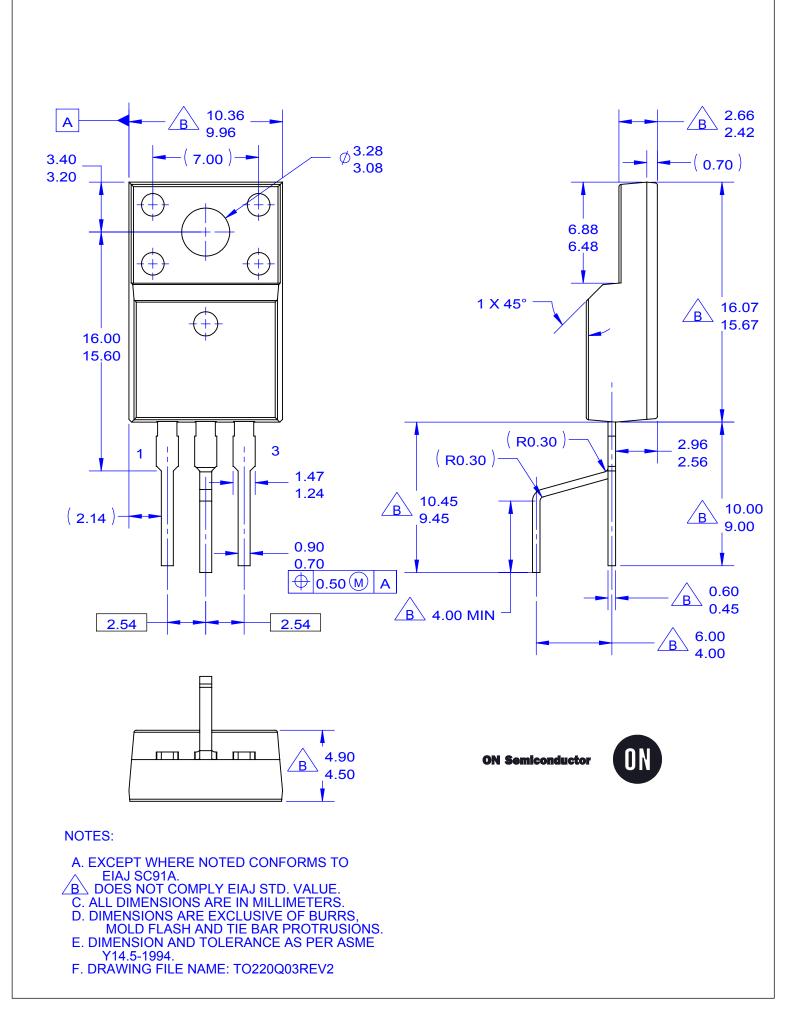
800

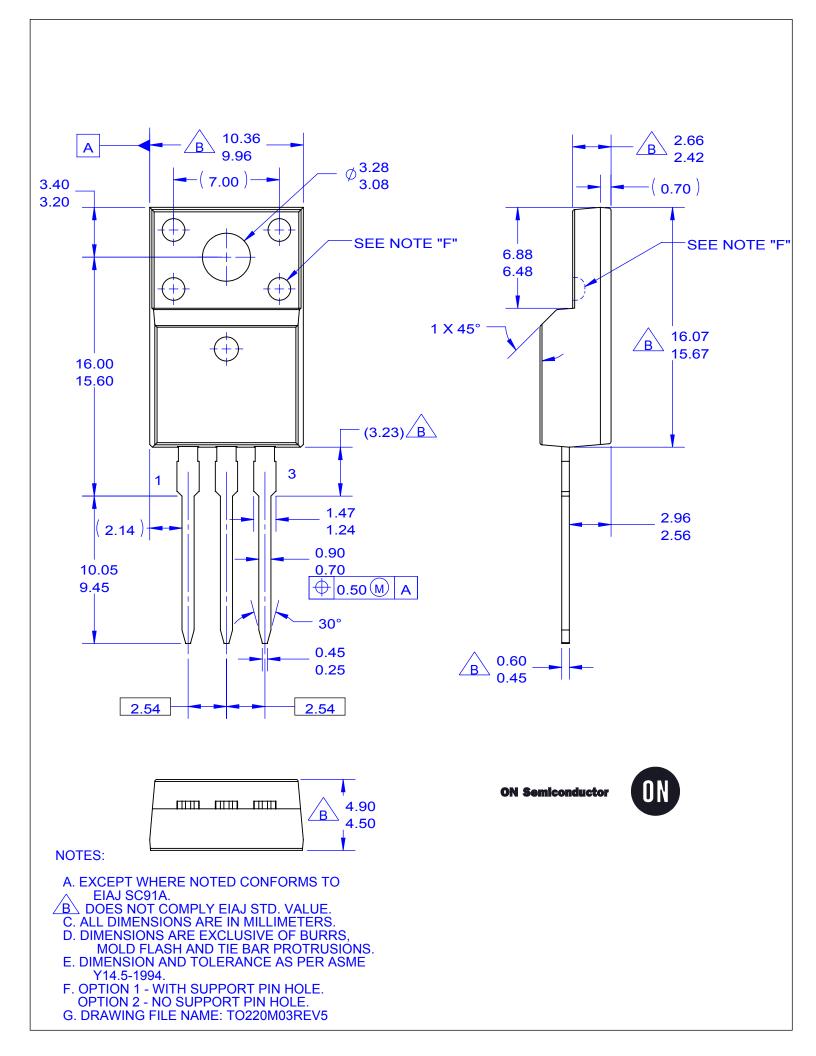




FCPF1300N80Z — N-Channel SuperFET<sup>®</sup> II MOSFET







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